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(12) **United States Design Patent** (10) **Patent No.:** **US D857,914 S**  
**LiCalzi et al.** (45) **Date of Patent:** **\*\* Aug. 27, 2019**

(54) **INSTRUMENT MODULE**

(56) **References Cited**

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Hartl**, Philadelphia, PA (US)

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(\*\*) Term: **15 Years**

(21) Appl. No.: **29/632,899**

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(Continued)

**Related U.S. Application Data**

(62) Division of application No. 29/569,389, filed on Jun.  
27, 2016, now Pat. No. Des. 812,241.

*Primary Examiner* — Wan Laymon

*Assistant Examiner* — Mark Booker

(51) **LOC (12) Cl.** ..... **24-01**

(57) **CLAIM**

The ornamental design for an instrument module, as shown  
and described.

(52) **U.S. Cl.**

USPC ..... **D24/216**

**DESCRIPTION**

(58) **Field of Classification Search**

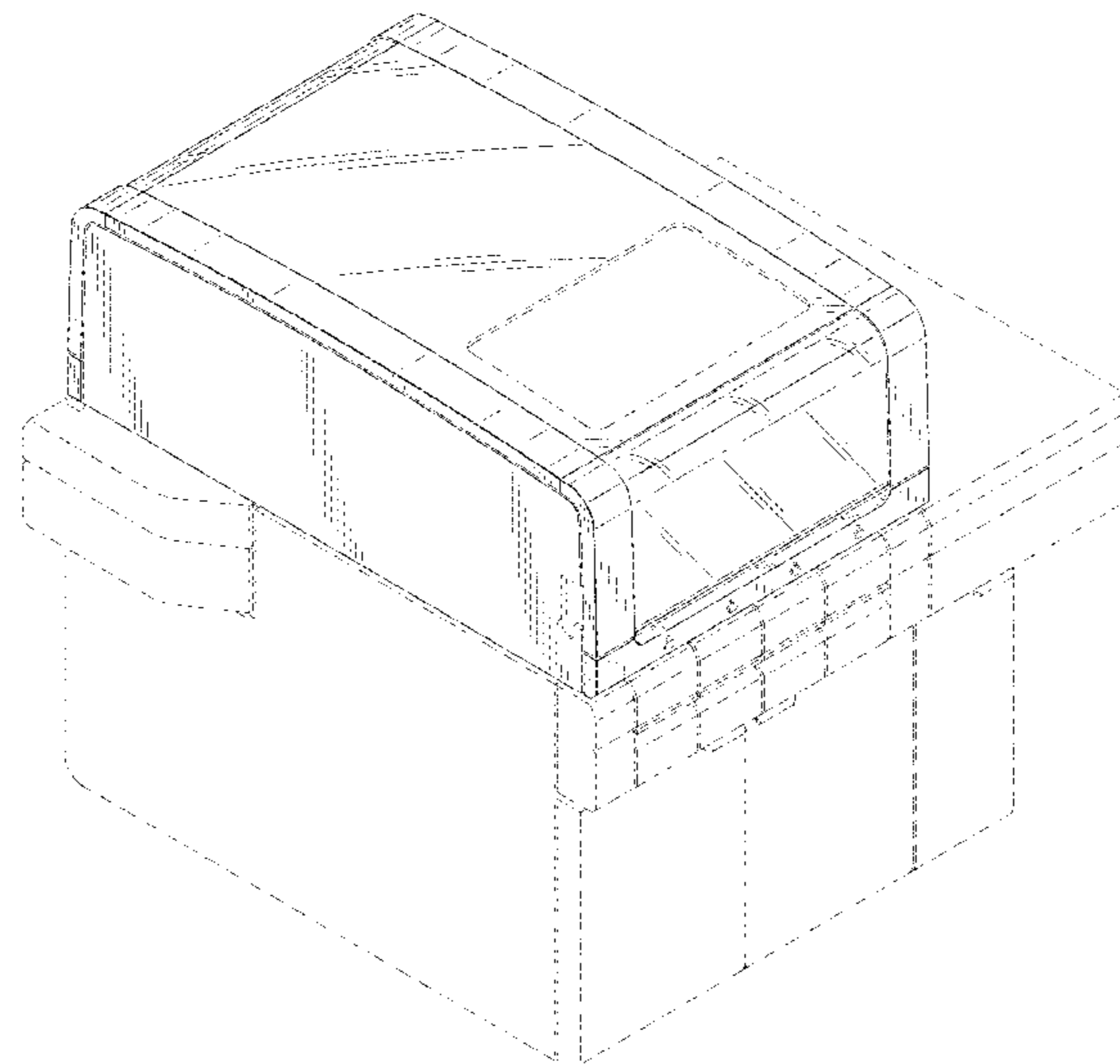
USPC ..... D24/216, 111, 127, 107, 169, 186, 217,  
D24/219, 223–224, 231–234; D10/46,  
D10/70, 81, 97; 422/1, 62–65, 67, 68.1,  
422/70, 81, 129, 500, 506, 561,  
422/FOR. 106; 435/287.1, 287.3;  
436/43, 45, 47; 600/300, 301, 368, 372,  
600/481, 529, 544, 554, 561; 607/4, 5, 9,  
607/30

FIG. 1 is a front perspective view of an instrument module;  
FIG. 2 is a rear perspective view of an instrument module;  
FIG. 3 is a front elevational view of an instrument module;  
FIG. 4 is a rear elevational view of an instrument module;  
FIG. 5 is a left side elevational view of an instrument  
module;  
FIG. 6 is a right side elevational view of an instrument  
module;  
FIG. 7 is a top view of an instrument module; and,  
FIG. 8 is a bottom view of an instrument module.

CPC ... G01R 31/31907; B04B 13/00; B04B 15/00;  
B04B 2005/0435; B04B 5/0421; A61B  
5/157; G06F 19/366; B01D 21/262

See application file for complete search history.

**1 Claim, 8 Drawing Sheets**



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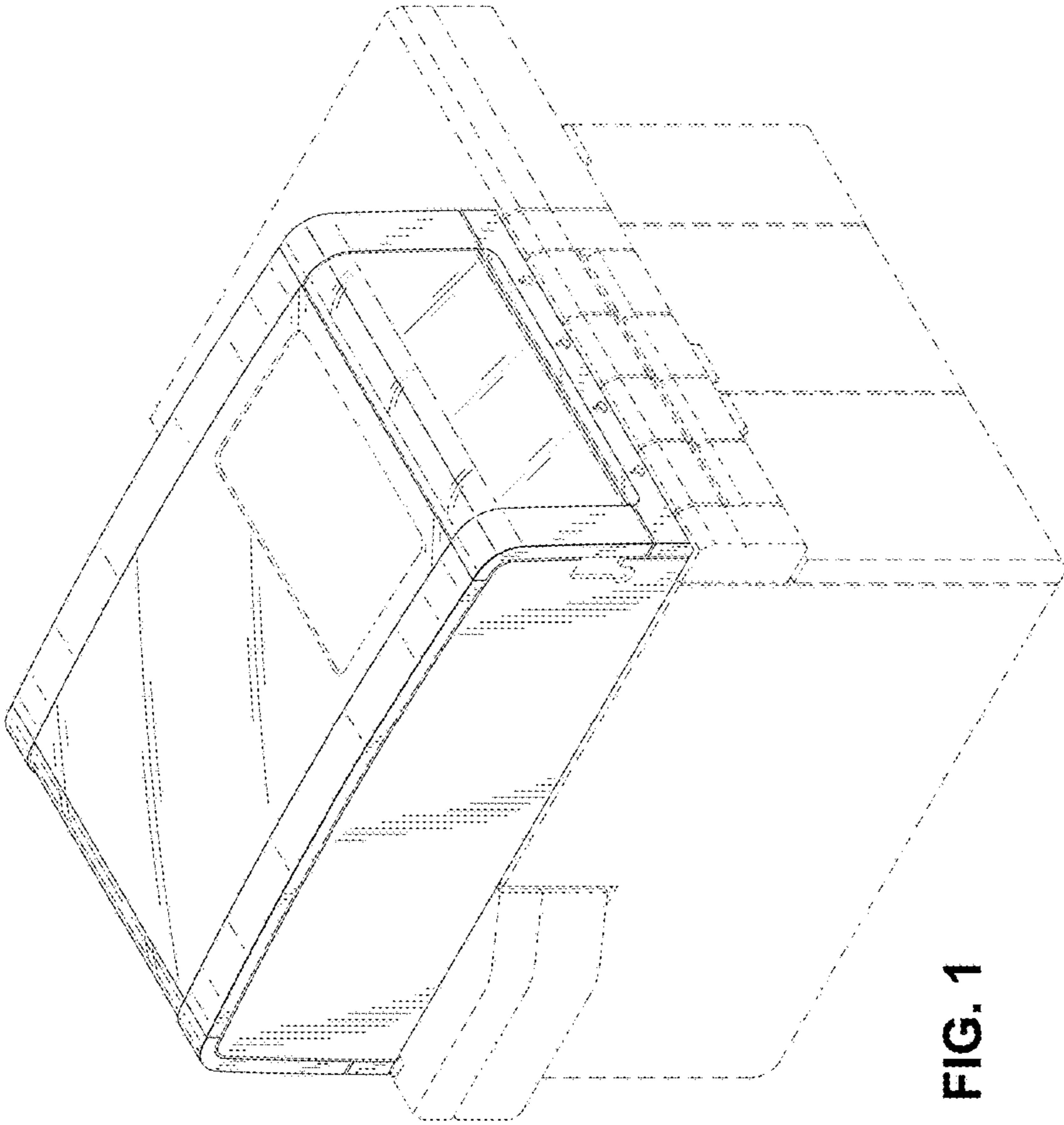


FIG. 1

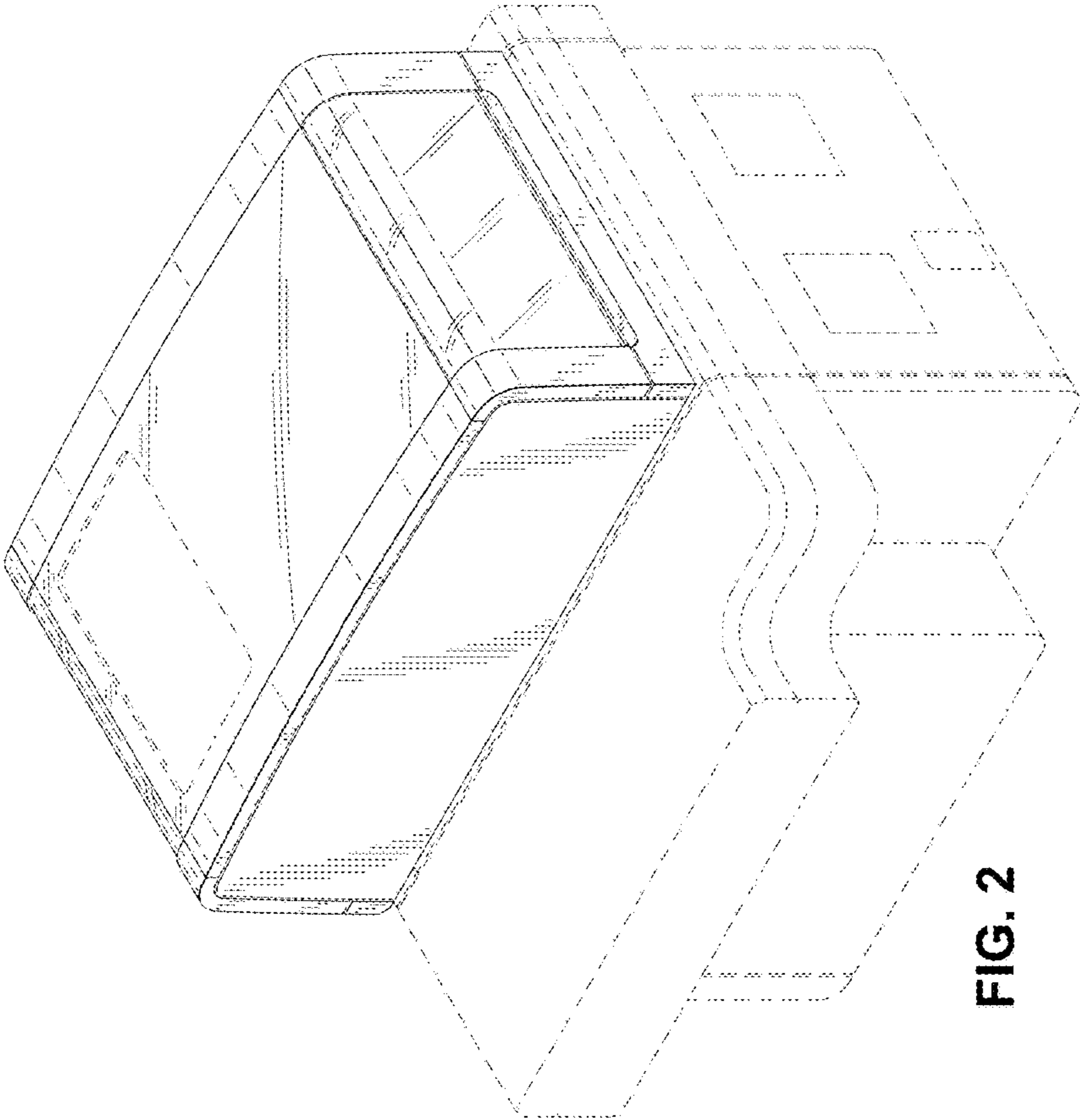


FIG. 2

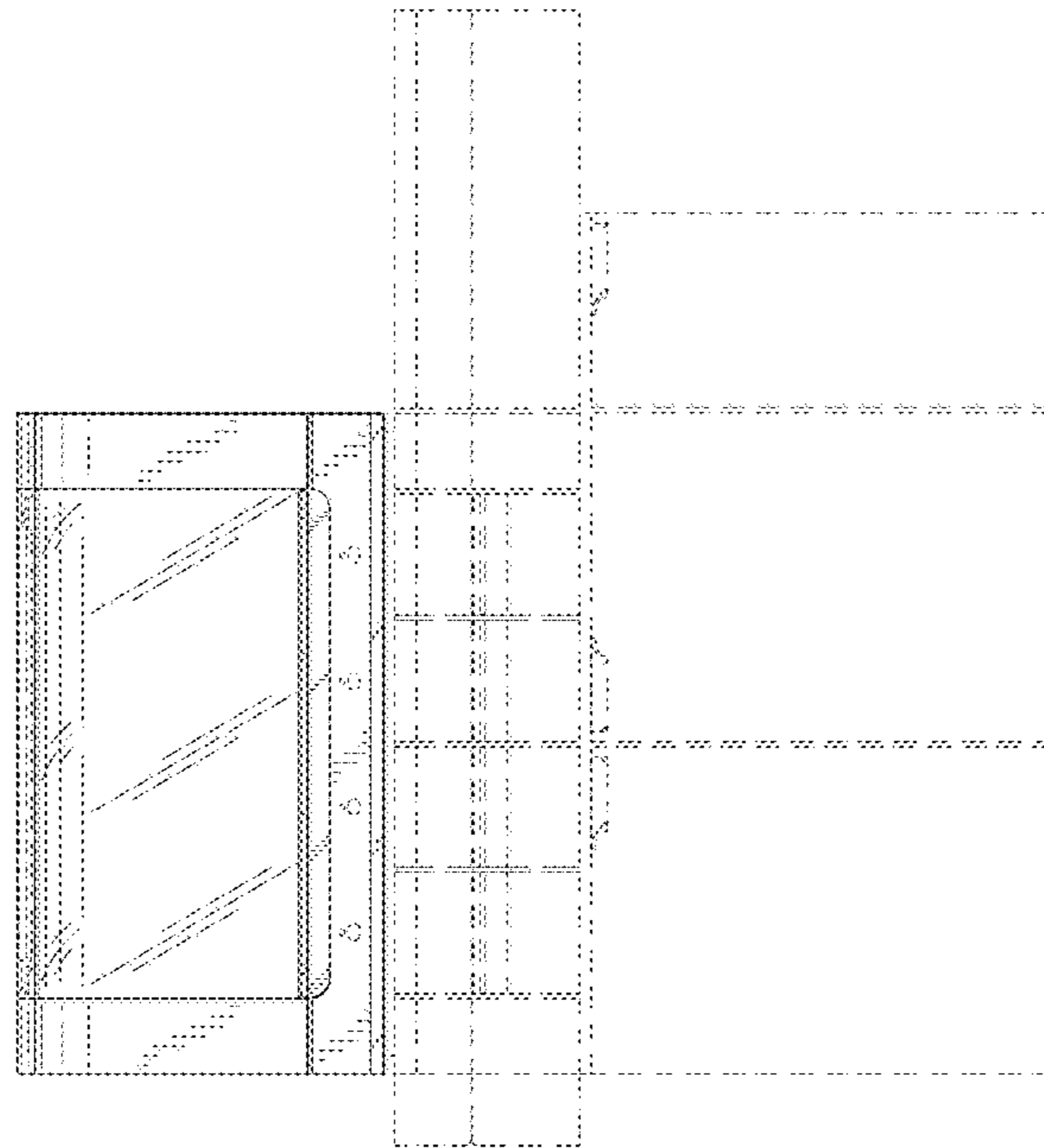


FIG. 3

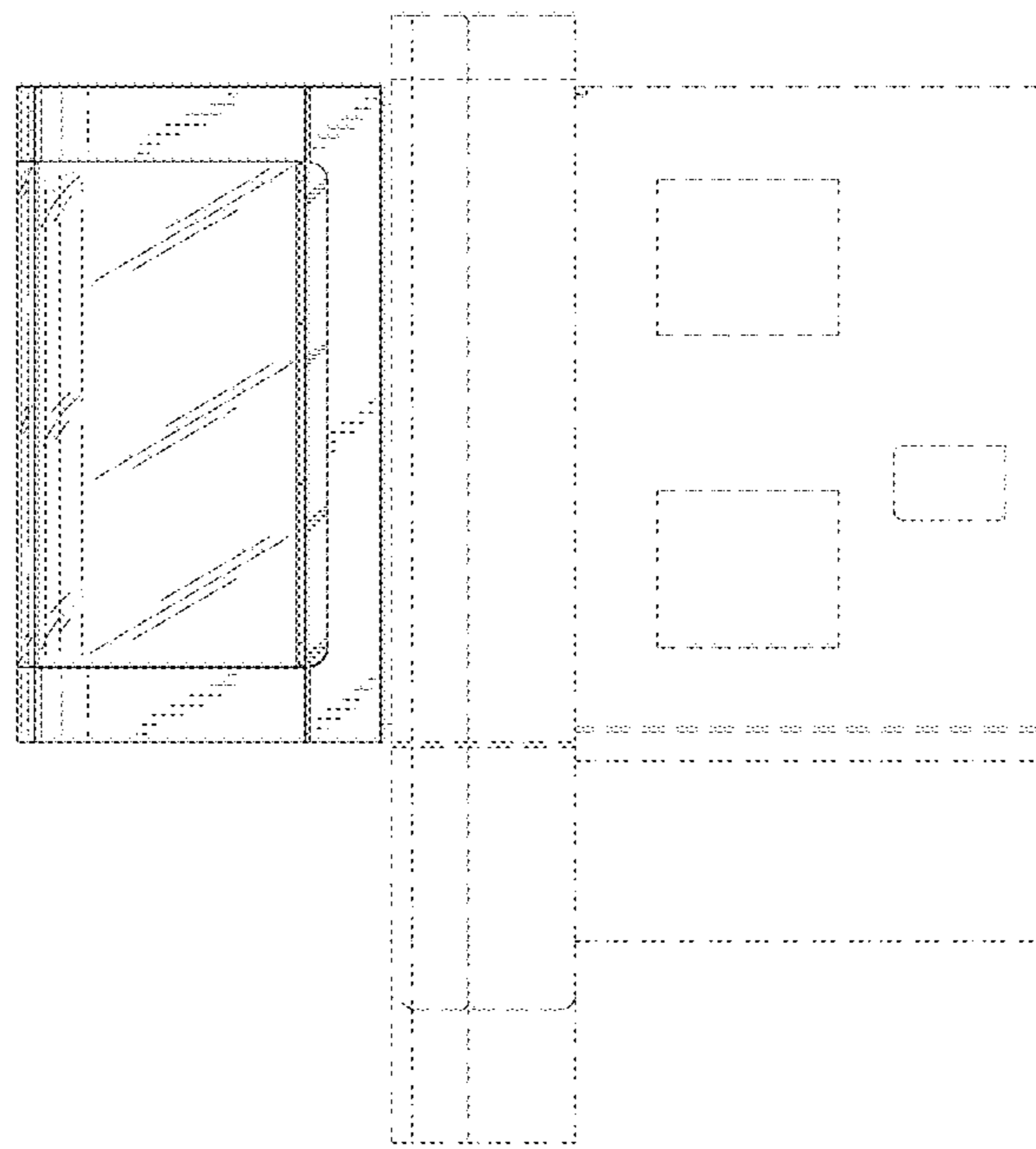


FIG. 4

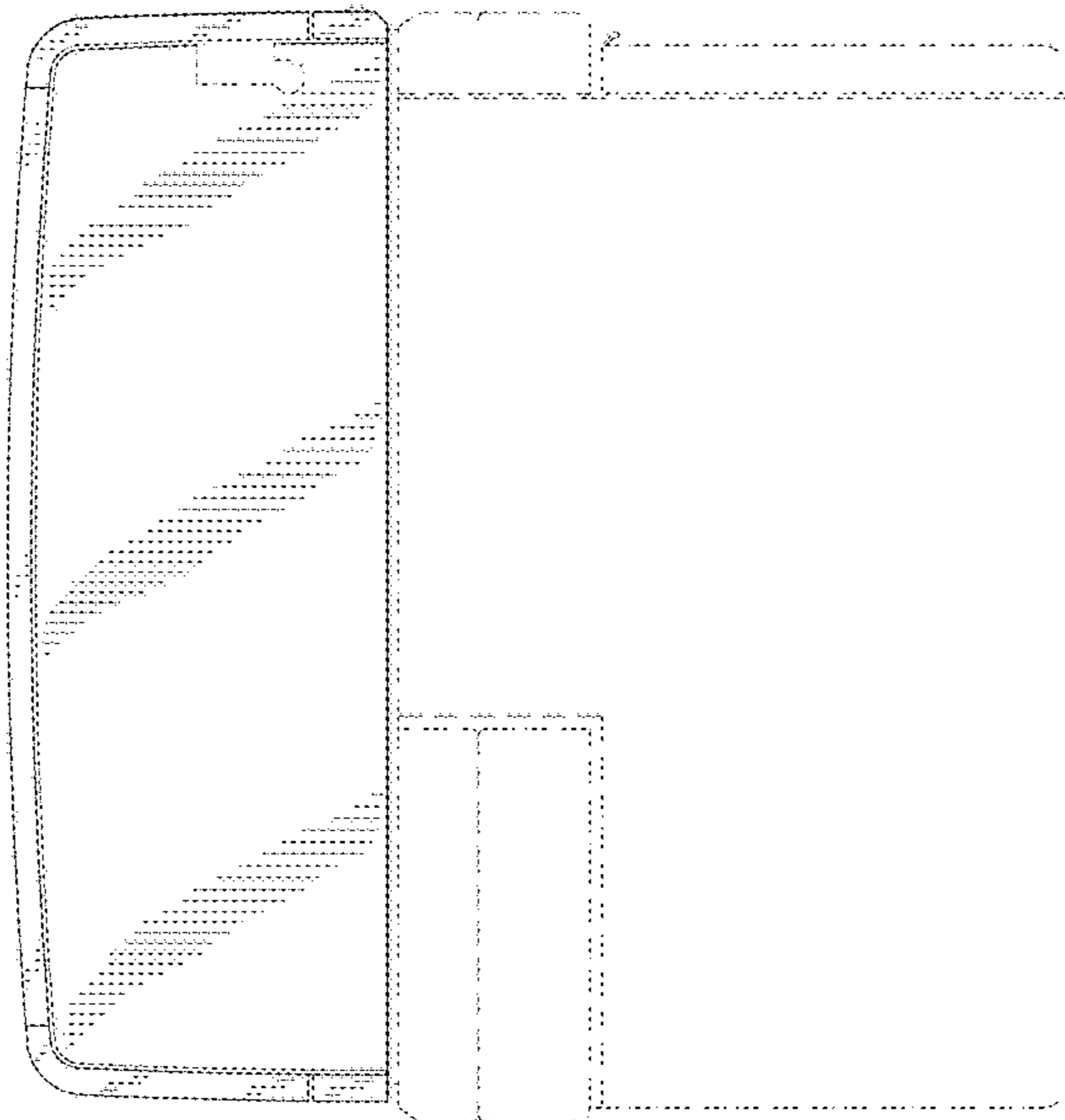


FIG. 5

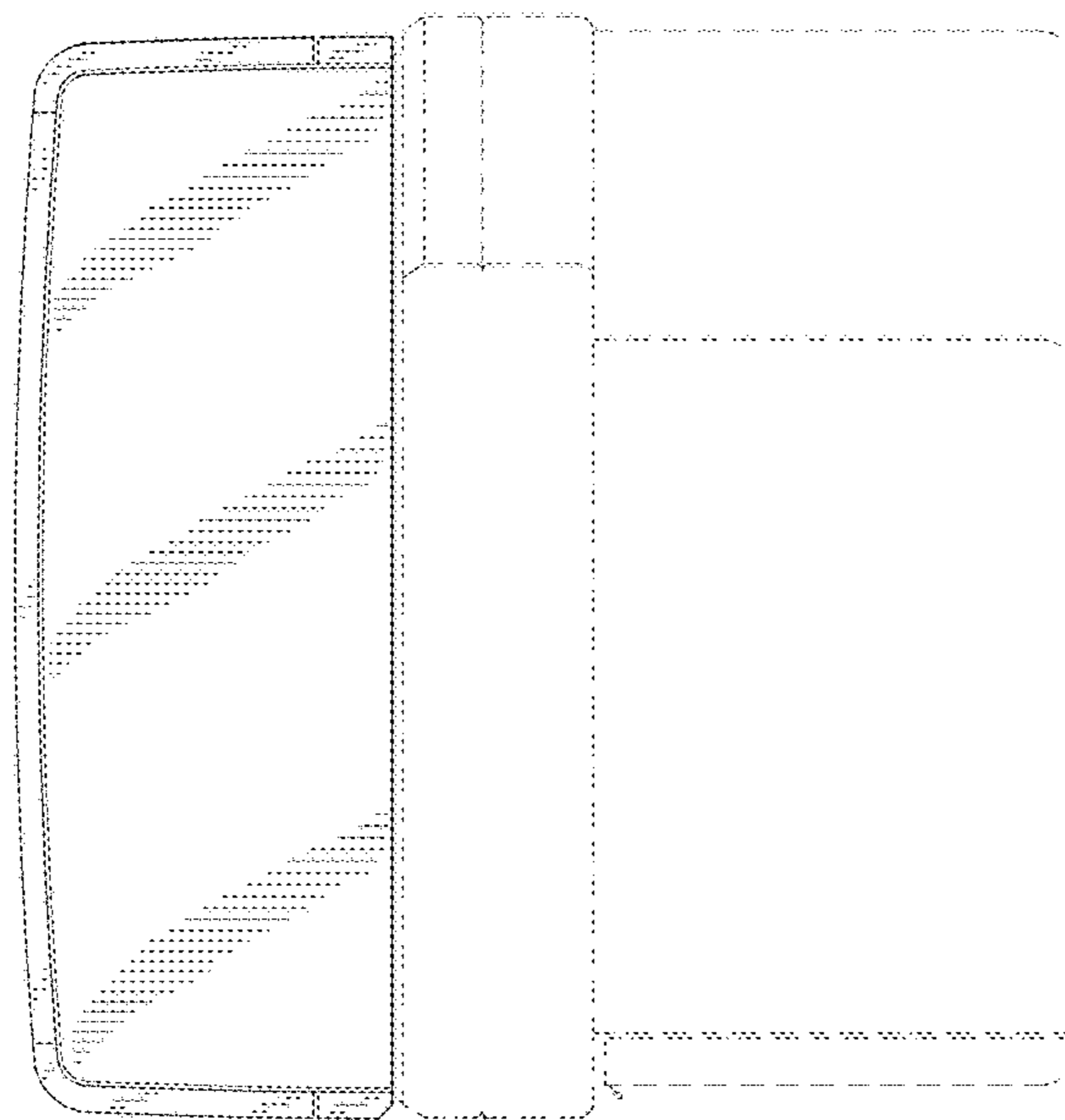


FIG. 6



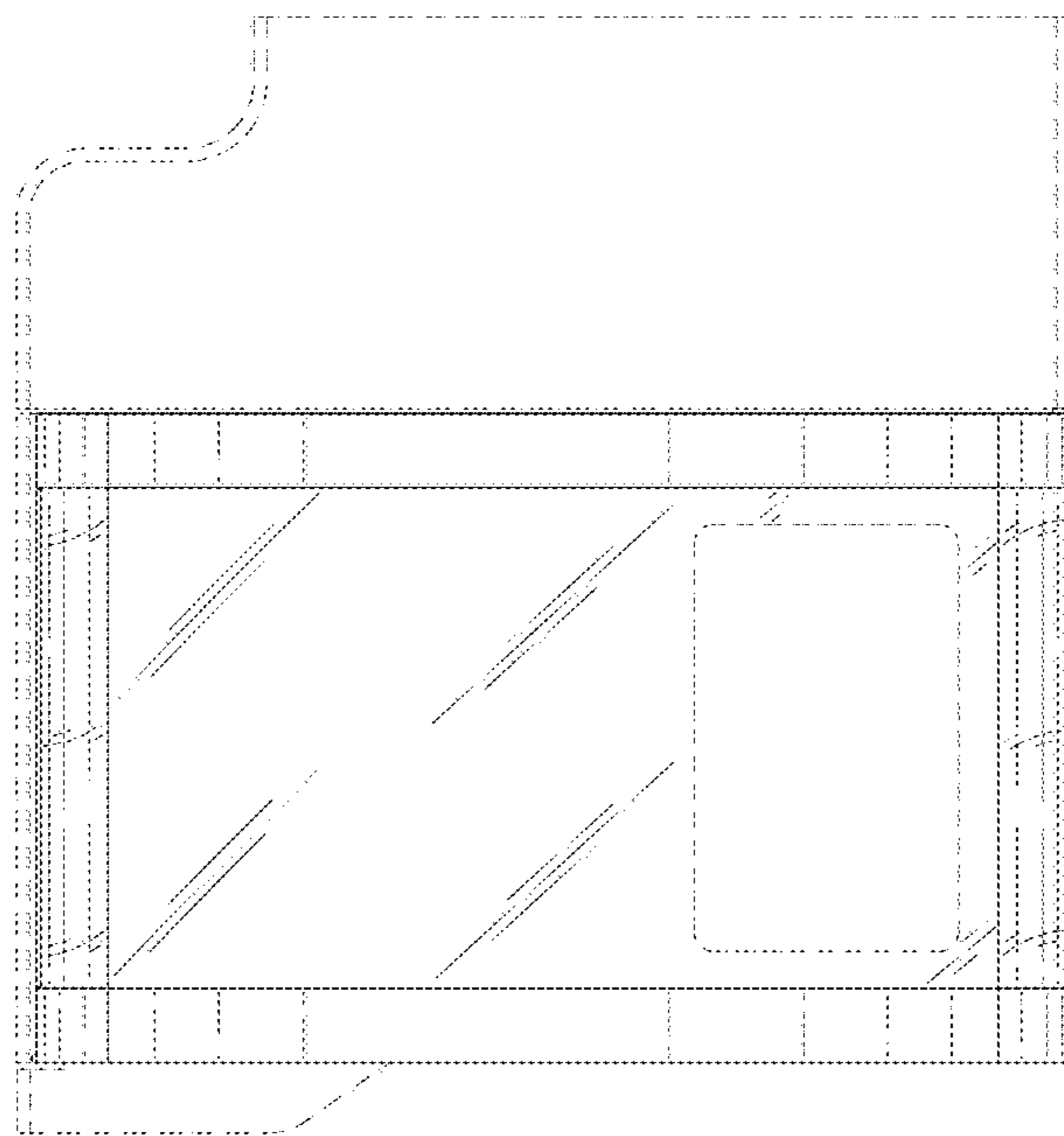


FIG. 7

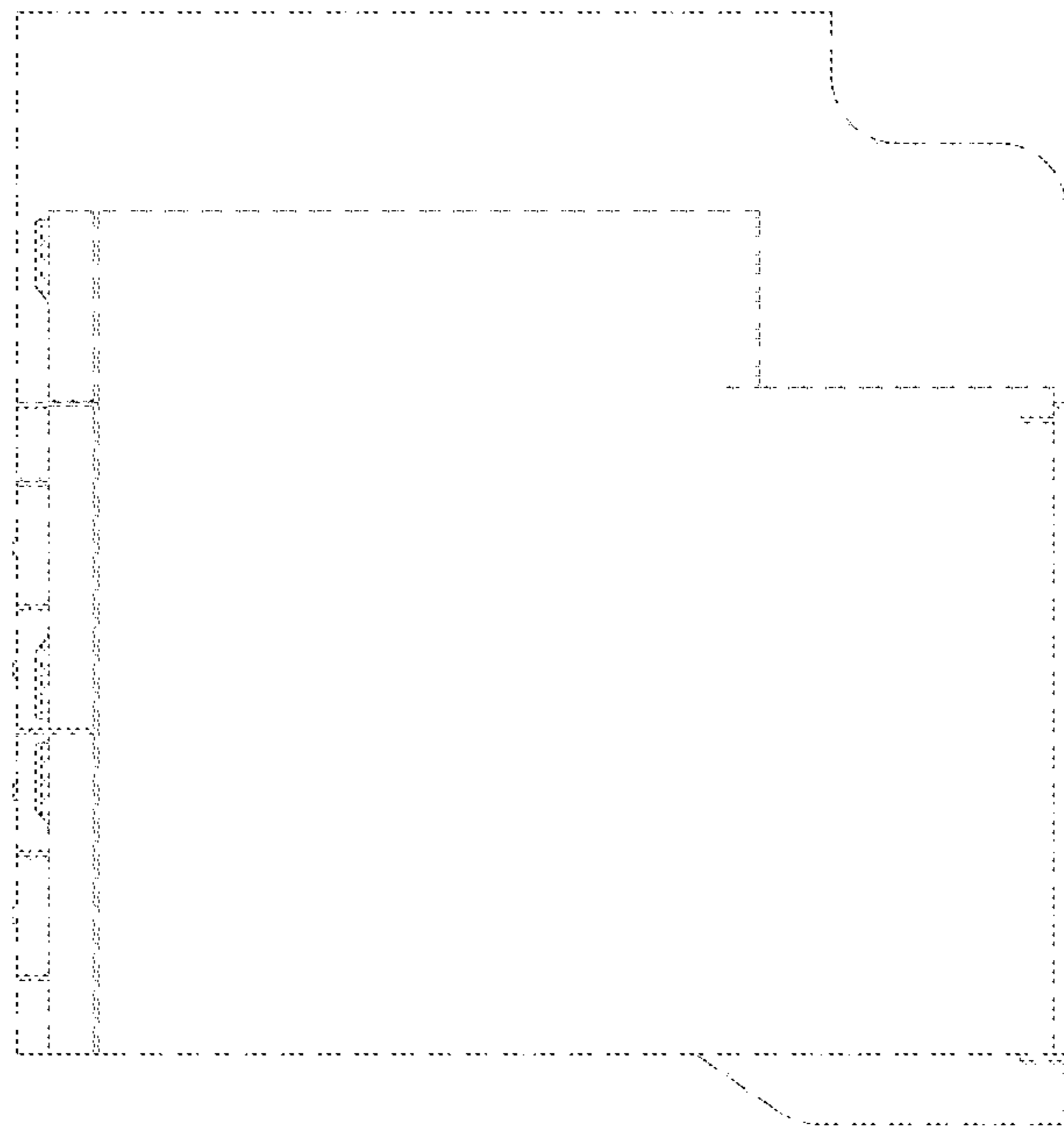


FIG. 8